

General Description

The MY035DPBF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

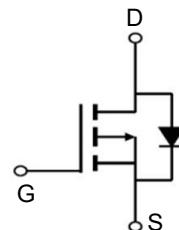
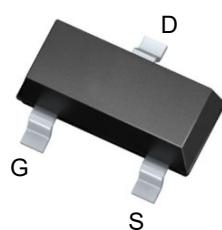


Features

V_{DSS}	-30	V
I_D	-7.9	A
$R_{DS(ON)}(\text{at } V_{GS} = -10\text{V})$	35	$\text{m}\Omega$
$R_{DS(ON)}(\text{at } V_{GS} = -4.5\text{V})$	60	$\text{m}\Omega$

Application

- Battery protection
- Load switch
- Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY035DPBF	SOT-23	MY035DPBF	3000

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	-30	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	-7.9	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	-9	A
$I_{DM(\text{pulse})}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	-30	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	1.4	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	19	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	$^\circ\text{C}$
R_{JC}	Thermal Resistance,Junction-to-Case	125	$^\circ\text{C}/\text{W}$

Electrical Characteristics ($T_A=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$			-1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1	-1.5	-2.5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-4.2\text{A}$		25		S
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-4.2\text{A}$		35	55	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-2.5\text{A}$		60	85	$\text{m}\Omega$
C_{iss}	Input Capacitance	$V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		520		pF
C_{oss}	Output Capacitance			100		pF
C_{rss}	Reverse Transfer Capacitance			65		pF
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-20\text{V}, R_{\text{L}}=1.6, R_{\text{GEN}}=3$		5		nS
t_r	Turn-on Rise Time			12		nS
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time			20		nS
t_f	Turn-Off Fall Time			4.5		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-15\text{V}, I_{\text{D}}=-3\text{A}$		5.9		nC
Q_{gs}	Gate-Source Charge			2.8		nC
Q_{gd}	Gate-Drain Charge			1		nC
I_{SD}	Source-Drain Current(Body Diode)				-7.9	A
V_{SD}	Forward on Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-20\text{A}$			-1.2	V

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Electrical and Thermal Characteristics

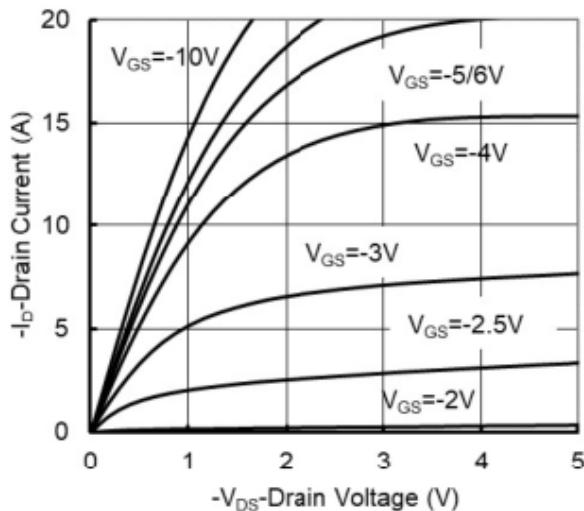


Figure 1. Output Characteristics

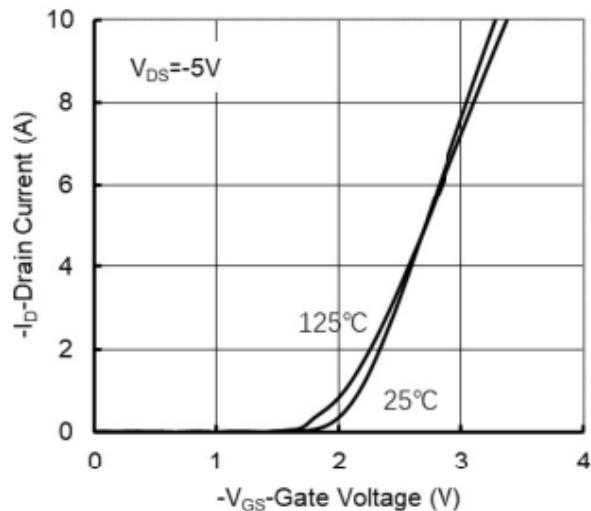


Figure 2. Transfer Characteristics

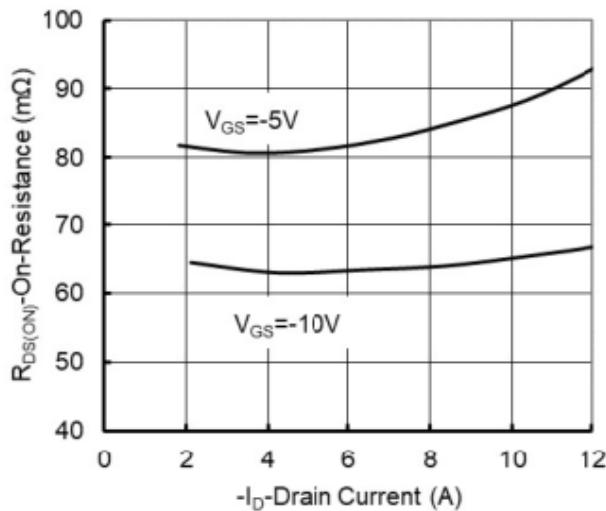


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

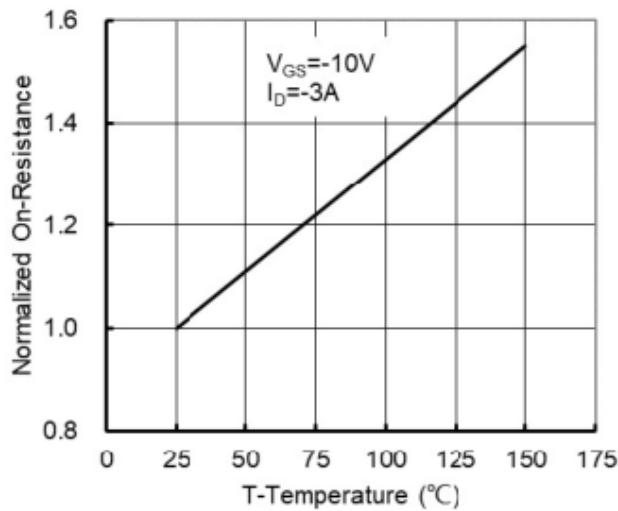


Figure 4: On-Resistance vs. Junction Temperature

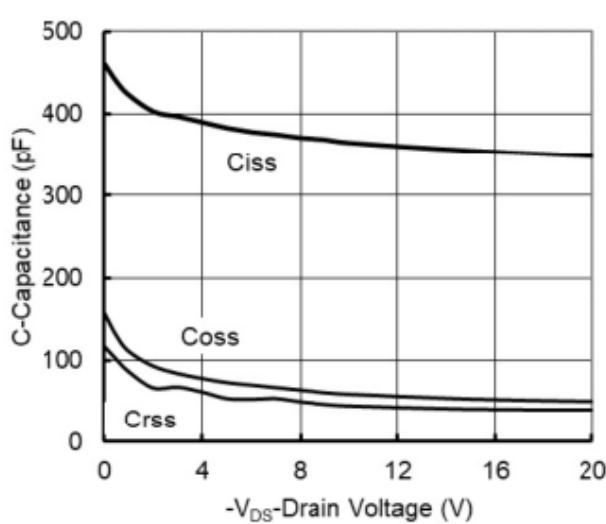


Figure 5. Capacitance Characteristics

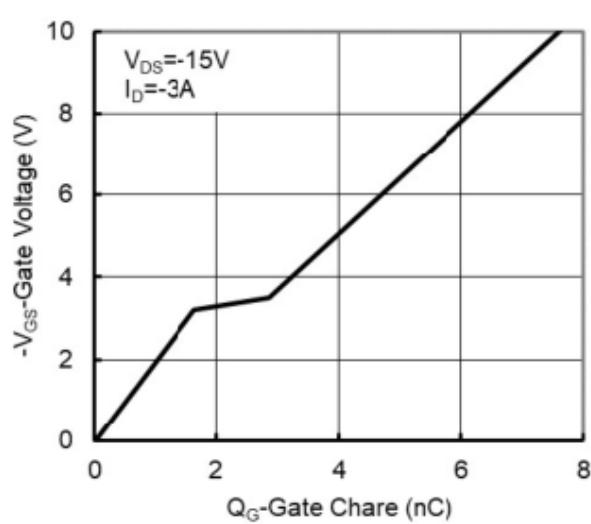
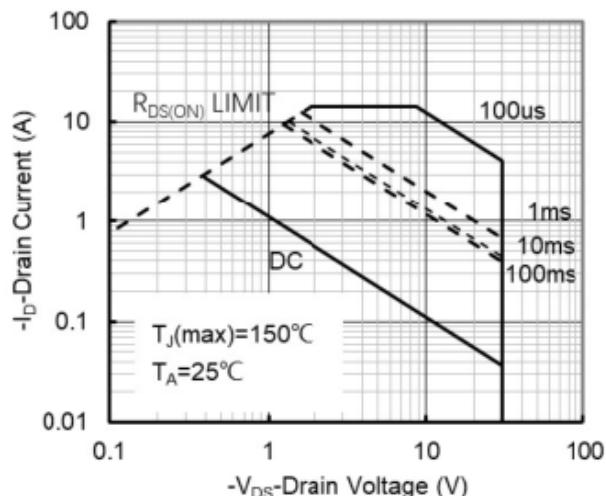
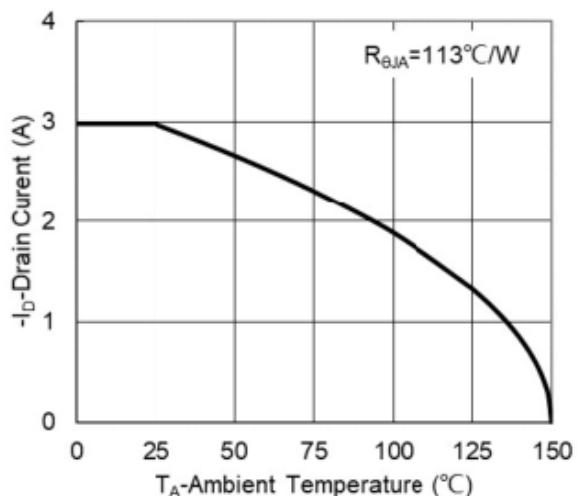
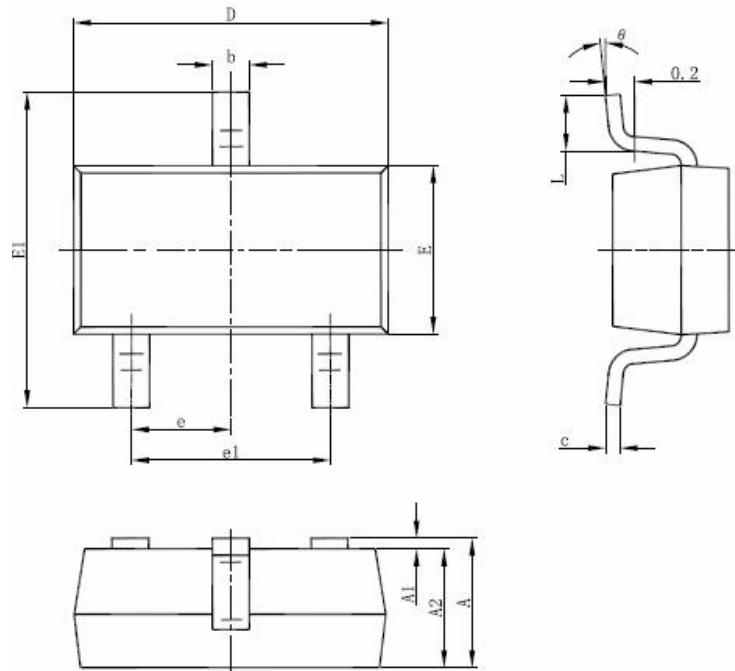


Figure 6. Gate Charge

**Figure7. Safe Operation Area****Figure8. Maximum Continuous Drain Current vs Ambient Temperature**

Package Mechanical Data-SOT-23


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°